

A

A

B

B

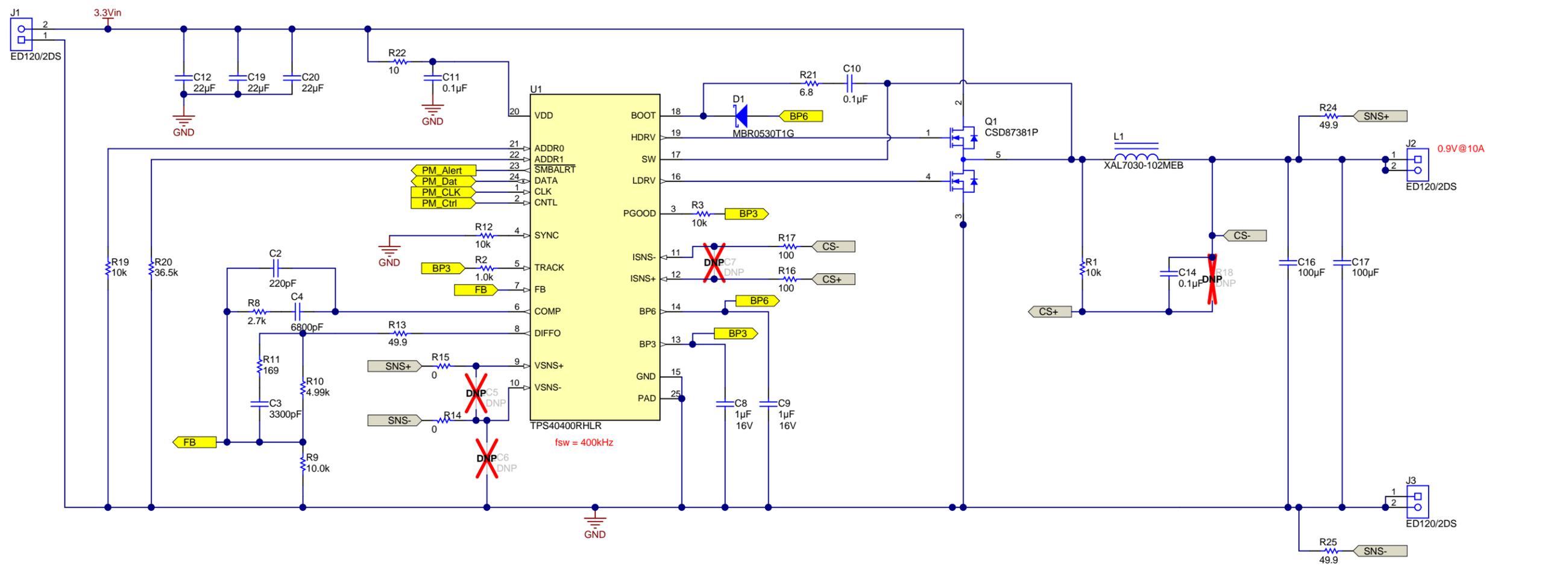
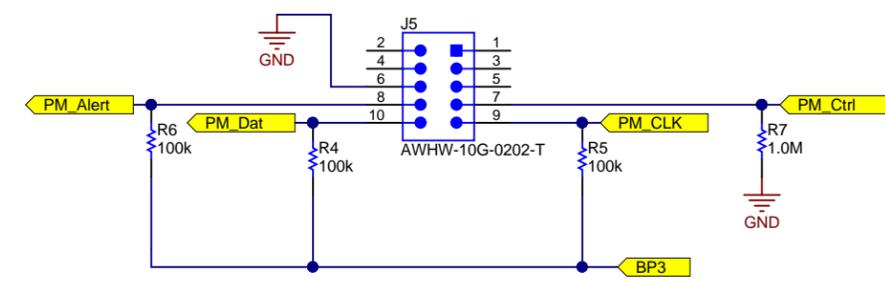
C

C

D

D

PMBUS Connector



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